

# VECTRA® E115I

## Liquid Crystal Polymer

15% glass reinforced Chemical abbreviation according to ISO 1043-1 : LCP Inherently flame retardant. UL-Listing V-0 black at 0.75mm thickness per UL 94 flame testing. UL = Underwriters Laboratories (USA)

### Product information

Resin Identification	LCP-GF15	ISO 1043
Part Marking Code	>LCP-GF15<	ISO 11469

### Typical mechanical properties

Tensile modulus	13000 MPa	ISO 527-1/-2
Tensile stress at break, 5mm/min	160 MPa	ISO 527-1/-2
Tensile strain at break, 5mm/min	2 %	ISO 527-1/-2
Flexural modulus	13000 MPa	ISO 178
Flexural strength	200 MPa	ISO 178
Charpy notched impact strength, 23°C	66 kJ/m <sup>2</sup>	ISO 179/1eA
Izod notched impact strength, 23°C	40 kJ/m <sup>2</sup>	ISO 180/1A
Izod impact strength, 23°C	101 kJ/m <sup>2</sup>	ISO 180/1U
Hardness, Rockwell, M-scale	43	ISO 2039-2
Poisson's ratio	0.33 <sup>[C]</sup>	

[C]: Calculated

### Thermal properties

Melting temperature, 10°C/min	335 °C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	260 °C	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	298 °C	ISO 75-1/-2
Vicat softening temperature, 50°C/h 50N	202 °C	ISO 306

### Flammability

Burning Behav. at thickness h	V-0 class	IEC 60695-11-10
Thickness tested	0.75 mm	IEC 60695-11-10
UL recognition	yes	UL 94

### Electrical properties

Relative permittivity, 1000Hz	3.79 <sup>[OT]</sup>	IEC 62631-2-1
Relative permittivity, 1MHz	3.4 <sup>[OT]</sup>	IEC 62631-2-1
Dissipation factor, 1000Hz	0 <sup>[OT]</sup> E-4	IEC 62631-2-1
Dissipation factor, 1MHz	340 <sup>[OT]</sup> E-4	IEC 62631-2-1
Dissipation factor, 1GHz	55 <sup>[OT, 1]</sup> E-4	IEC 61189-2-721
Volume resistivity	1E14 Ohm.m	IEC 62631-3-1
Surface resistivity	>1E15 Ohm	IEC 62631-3-2
Electric strength	33 kV/mm	IEC 60243-1
Relative permittivity, printed circuits and boards, 2.5 GHz	3.9 <sup>[OT, 2]</sup>	IEC 61189-2-721
Dissipation factor, printed circuits and boards, 2.5 GHz	60 <sup>[OT, 2]</sup> E-4	IEC 61189-2-721

[OT]: One time tested

[1]: Service Request Case No.: 00073539

[2]: Shifted data from 1.9GHz to 2.0GHz for harmonization purpose, only use 'whole' numbers

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### Physical/Other properties

Density 1460 kg/m<sup>3</sup> ISO 1183

### Injection

Drying Recommended	yes
Drying Temperature	150 °C
Drying Time, Dehumidified Dryer	4 - 6 h
Processing Moisture Content	≤0.01 %
Melt Temperature Optimum	340 °C
Min. melt temperature	335 °C
Max. melt temperature	345 °C
Screw tangential speed	0.2 - 0.3 m/s
Mold Temperature Optimum	100 °C
Min. mould temperature	80 °C
Max. mould temperature	120 °C
Back pressure	3 MPa
Ejection temperature	270 °C

### Characteristics

Processing	Injection Moulding
Special characteristics	Flame retardant, Heat stabilised or stable to heat, High Flow, Lead-free soldering resistant

### Additional information

Processing Notes

#### Pre-Drying

VECTRA should in principle be predried. Because of the necessary low maximum residual moisture content the use of dry air dryers is recommended. The dew point should be =< - 40° C. The time between drying and processing should be as short as possible.

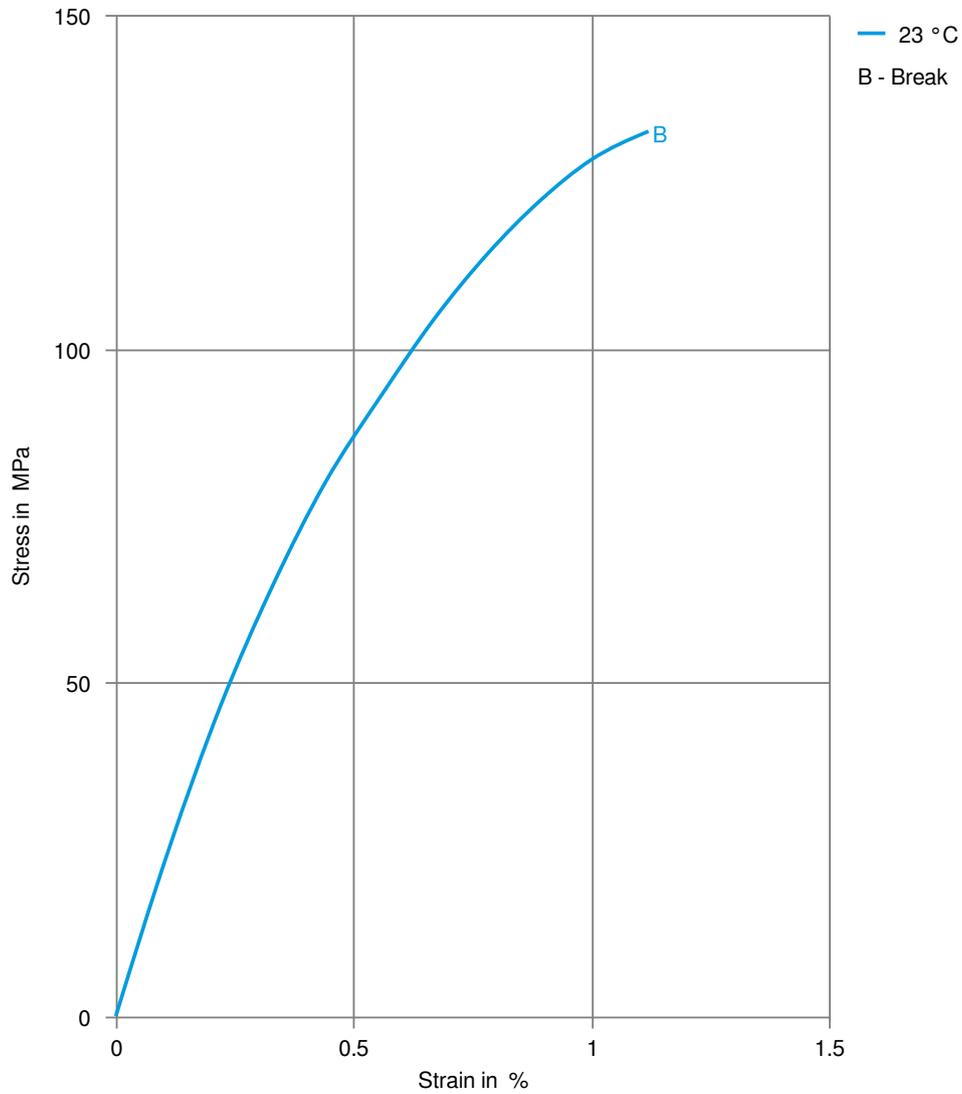
#### Storage

For subsequent storage of the material in the dryer until processed the temperature does not need to be lowered for grades A, B, C, D and V (<= 24 h).

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## Stress-strain



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Liquid Crystal Polymer

## Secant modulus-strain

